



# Product Change Notification

**Change Notification #:** 114886 - 00  
**Change Title:** Select Intel® SSD 600p Series Products  
 PCN 114886-00, Label,  
 Label Update

**Date of Publication:** September 12, 2016

**Key Characteristics of the Change:**  
 Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	September 27, 2016
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## Description of Change to the Customer:

The select Intel® SSD 600p Series skus listed in the Products Affected Table below will be changing from a 2-sided to a 1-sided label. See example labels provided below:

**Current top and bottom label:**



**New Combined label:**



**Customer Impact of Change and Recommended Action:**

There is no change to the form, fit, or function of the product. The change is only to the labels used in packaging. Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customer will need to manage and migrate to the post-conversion material as soon as possible. Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

**Products Affected / Intel Ordering Codes:**

Marketing Name	Product Code	MM#
Intel® SSD 600p Series (128GB, M.2 80mm PCIe 3.0 x4, 3D1, TLC) Reseller Single Pack	SSDPEKKW128G7X1	950358
Intel® SSD 600p Series (256GB, M.2 80mm PCIe 3.0 x4, 3D1, TLC) Reseller Single Pack	SSDPEKKW256G7X1	950359
Intel® SSD 600p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D1, TLC) Reseller Single Pack	SSDPEKKW512G7X1	950360

**PCN Revision History:**

Date of Revision:	Revision Number:	Reason:
September 12, 2016	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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